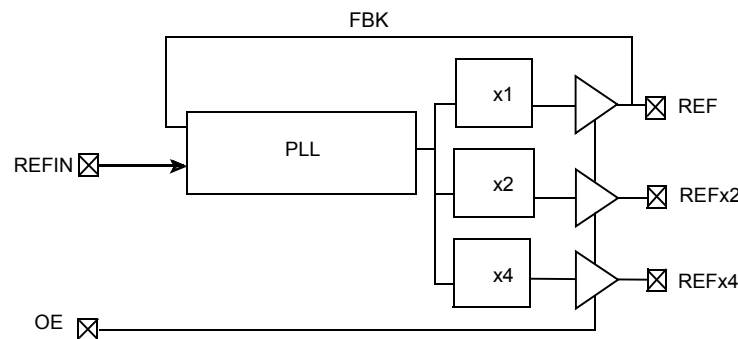## Features

- 3-Multiplier configuration (1x, 2x, 4x ref)

- 10 MHz to 166.67 MHz operating range (reference input from 10 MHz to 41.67 MHz)

- Phase alignment

- 80 ps typical period jitter

- Output enable pin

- 3.3 V operation

- 5 V tolerant input

- 8-pin 150-mil small-outline integrated circuit (SOIC) package

- Commercial temperature range

Functional Description

The CY2303 is a 3 output 3.3 V phase-aligned system clock designed to distribute high-speed clocks in PC, workstation, datacom, telecom, and other high-performance applications.
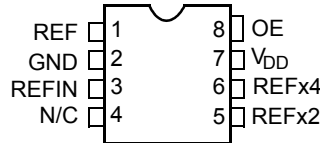
The part allows user to obtain 1x, 2x, and 4x REFIN output frequencies on respective output pins.

The CY2303 has an on-chip PLL, which locks to an input clock presented on the REFIN pin. The PLL feedback is internally connected to the REF output. The input-to-output is guaranteed to be less than ±200 ps, and output-to-output skew is guaranteed to be less than 200 ps.

Multiple CY2303 devices can accept the same input clock and distribute it in a system. In this case, the skew between the outputs of two devices is guaranteed to be less than 400 ps.

Logic Block Diagram

[+] Feedback

Pinouts

Figure 1. CY2303 - 8-pin SOIC Top View

```
        ┌──────┐
REF  ──┤1    8├── OE
GND  ──┤2    7├── V_DD
REFIN──┤3    6├── REFx4
N/C  ──┤4    5├── REFx2
        └──────┘
```

Pin Description

Pin	Signal[1]	Description
1	REF	REF output (1x reference input)
2	GND	Ground
3	REFIN	Input reference frequency, 5 V tolerant input
4	N/C	No connect
5	REFx2	2x reference input
6	REFx4	4x reference input
7	V_{DD}	3.3 V supply
8	OE	Output enable (weak pull-up)

Maximum Ratings

Supply voltage to ground potential ....–0.5 V to +7.0 V

DC input voltage (except ref)...............–0.5 V to V_{DD} + 0.5 V

DC input voltage REFIN ....–0.5 V to 7 V

Storage temperature .... –65 °C to +150 °C

Junction temperature.. 150 °C

Static discharge voltage
(per MIL-STD-883, method 3015) ....> 2000 V

Operating Conditions

| Parameter	Description	Min	Max	Unit
V_{DD}	Supply voltage	3.0	3.6	V
T_A	Operating temperature (ambient temperature)	0	70	°C
C_L	Load capacitance, 10 MHz < F_{OUT} < 133.33 MHz	–	18	pF
	Load capacitance, 133.33 MHz < F_{OUT} < 166.67 MHz	–	12	pF
C_{IN}	Input capacitance	–	7	pF
t_{PU}	Power-up time for all V_{DD}'s to reach minimum specified voltage (power ramps must be monotonic)	0.05	50	ms

Notes
1. Weak pull-down on all outputs.

[+] Feedback

Electrical Characteristics

Parameter	Description	Test Conditions	Min	Max	Unit
V_{IL}	Input LOW voltage		–	0.8	V
V_{IH}	Input HIGH voltage		2.0	–	V
I_{IL}	Input LOW current	V_{IN} = 0 V	–	100	µA
I_{IH}	Input HIGH current	$V_{IN} = V_{DD}$	–	50	µA
V_{OL}	Output LOW voltage[2]	I_{OL} = 8 mA	–	0.4	V
V_{OH}	Output HIGH voltage[2]	I_{OH} = –8 mA	2.4	–	V
I_{DD}	Supply current	Unloaded outputs, REFIN = 41.67 MHz	–	45	mA
		Unloaded outputs, REFIN = 25 MHz	–	32	mA
		Unloaded outputs, REFIN = 10 MHz	–	18	mA

Switching Characteristics

Parameter	Name	Test Conditions	Min	Typ	Max	Unit
$1/t_1$	Output frequency	18-pF load	10	–	133.33	MHz
		12-pF load	–	–	166.67	MHz
	Duty cycle[3] = $t_2 \div t_1$	Measured at $V_{DD}/2$	40	50	60	%
t_3	Rise time[3]	Measured between 0.8 V and 2.0 V	–	–	1.20	ns
t_4	Fall time[3]	Measured between 0.8 V and 2.0 V	–	–	1.20	ns
t_5	Output to output skew on rising edges[3]	All outputs equally loaded Measured at $V_{DD}/2$	–	–	200	ps
t_6	Delay, REFIN rising edge to REF rising edge[3]	Measured at $V_{DD}/2$ from REFIN to any output	–	–	±200	ps
t_7	Device to device skew[3]	Measured at $V_{DD}/2$ on the REF pin of the device (pin 1)	–	–	400	ps
t_J	Period jitter[3]	Measured at F_{OUT} < 133.33 MHz, loaded outputs, 18-pF load	–	±80	±175	ps
t_{LOCK}	PLL lock time[3]	Stable power supply, valid clocks presented on REFIN	–	–	1.0	ms

Switching Waveforms

Figure 2. Duty Cycle Timing
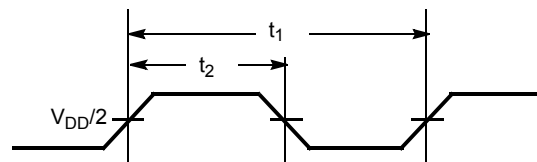
Notes
2. Parameter is guaranteed by design and characterization. It is not 100% tested in production.
3. All parameters are specified with loaded outputs.

[+] Feedback

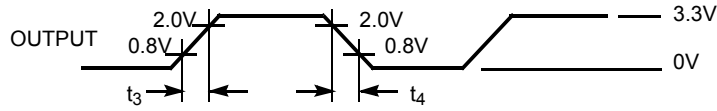## Switching Waveforms (continued)

Figure 3. All Outputs Rise/Fall Time

OUTPUT 2.0V 2.0V 3.3V
0.8V 0.8V 0V
t_3 t_4

Figure 4. Output to Output Skew

OUTPUT $V_{DD}/2$
OUTPUT $V_{DD}/2$
t_5
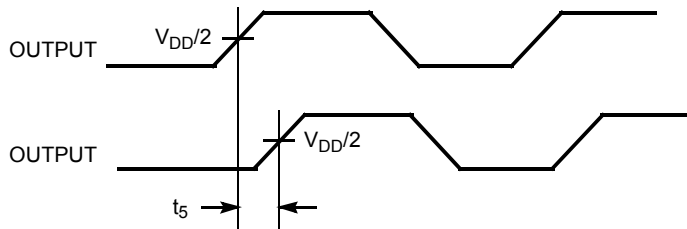
Figure 5. Input to Output Propagation Delay

INPUT $V_{DD}/2$
FBK $V_{DD}/2$
t_6
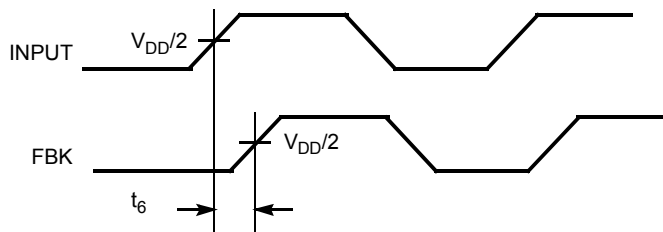
Figure 6. Device to Device Skew

FBK, Device 1 $V_{DD}/2$
FBK, Device 2 $V_{DD}/2$
t_7
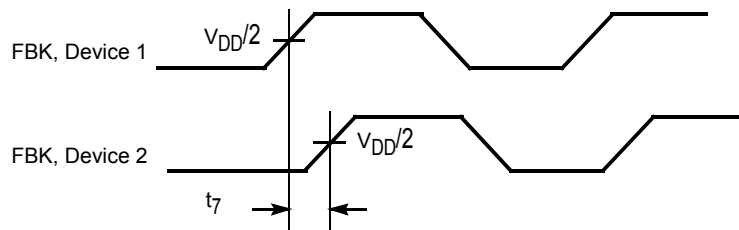
Test Circuits

Figure 7. Test Circuit #1
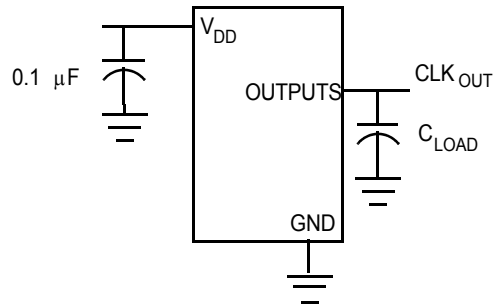
Ordering Information

Ordering Code	Package Type	Operating Range
Pb-free		
CY2303SXC	8-pin 150-mil SOIC	Commercial (0 to 70 °C)
CY2303SXCT	8-pin 150-mil SOIC - Tape and Reel	Commercial (0 to 70 °C)

Ordering Code Definitions

CY 2303 S X C (T)

T = Tape and Reel, **Blank** = Tube
Temperature Grade: C = Commercial
Fixed for Pb-free
Package Type: S = SOIC
Part Identifier
Company ID: CY = Cypress
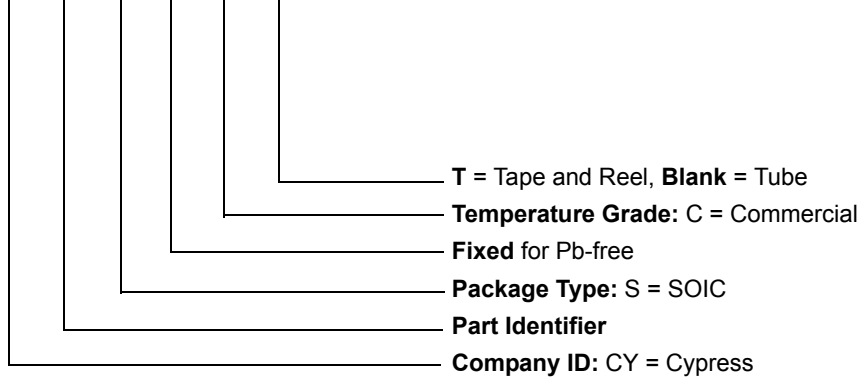
Package Diagram

Figure 8. 8-pin (150-Mil) SOIC S8

1.   DIMENSIONS IN INCHES[MM] MIN.
                              MAX.

2.   PIN 1 ID IS OPTIONAL,
     ROUND ON SINGLE LEADFRAME
     RECTANGULAR ON MATRIX LEADFRAME

3.   REFERENCE JEDEC MS-012

4.   PACKAGE WEIGHT 0.07gms

PART #	
S08.15	STANDARD PKG.
SZ08.15	LEAD FREE PKG.
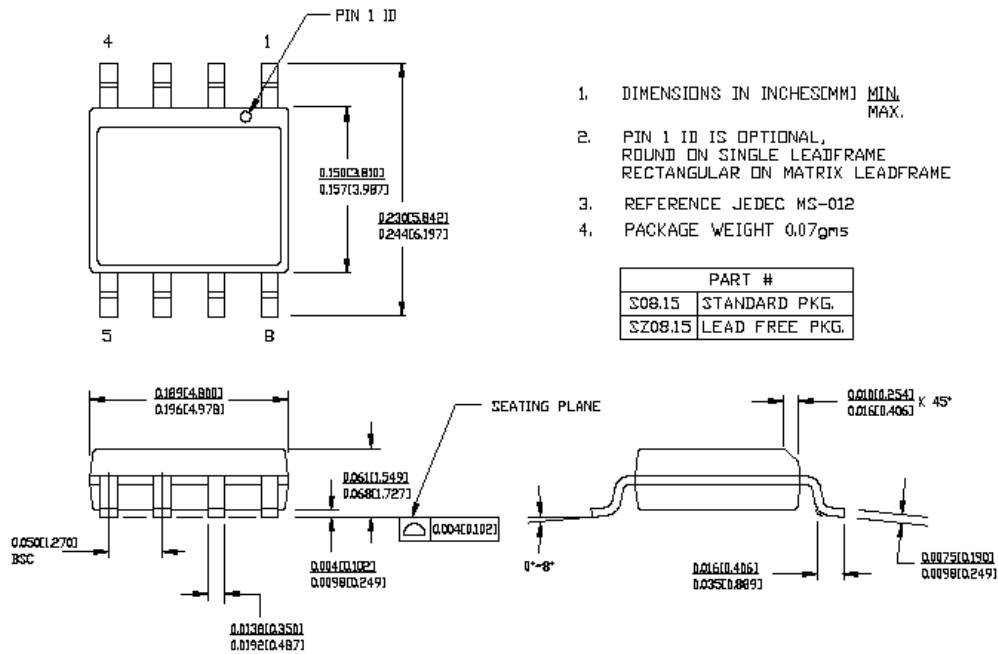
51-85066 *D

Acronyms

Acronym	Description
FBK	Feedback
OE	Output enable
PLL	Phase locked loop
REFIN	Reference input

Reference Documents

Reference documents are available through your local Cypress sales representative. You can also direct your requests to tsbusdev@cypress.com.

Document Number	Document Title	Description
NA	NA	NA

Document Conventions

Units of Measure

Symbol	Unit of Measure
°C	degrees Celsius
Hz	Hertz
kHz	kilo Hertz
MHz	Mega Hertz
µA	micro Amperes
µF	micro Farads
µs	micro seconds
µV	micro Volts
mA	milli Amperes
mm	milli meters
ms	milli seconds
mV	milli Volts
ns	nano seconds
pA	pico Amperes
pF	pico Farads
ps	pico seconds
V	Volts

Document History Page

Document Title: CY2303 Phase-Aligned Clock Multiplier				
Document Number: 38-07249				
REV.	**ECN**	**Orig. of Change**	**Submission Date**	**Description of Change**
**	110514	SZV	01/07/02	Change from Spec number: 38-01036 to 38-07249
*A	121852	RBI	12/14/02	Power up requirements added to Operating Conditions Information
*B	390413	RGL	08/10/05	Added Lead-free devices Added typical values for jitter
*C	2568533	AESA	09/23/08	Updated template. Removed part number CY2303SC and CY2303SI from Selector Guide table. Removed part number CY2303SC, CY2303SCT, CY2303SI, and CY2303SIT.
*D	2897294	KVM	03/22/10	Removed part numbers CY2303SXI and CY2303SXIT from ordering information table and related industrial temperature references. Updated package diagram. Updated copyright section.
*E	3026183	BASH	09/01/2010	Updated t_J from 80 ps to $\pm$80 ps in Switching Characteristics on page 3. Ordering Code Definitions added on page 6. Acronyms, Reference Documents and Document Conventions added on page 7.

Sales, Solutions, and Legal Information

Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

Products

Automotive	cypress.com/go/automotive	**PSoC Solutions**
Clocks & Buffers	cypress.com/go/clocks	psoc.cypress.com/solutions
Interface	cypress.com/go/interface	PSoC 1 | PSoC 3 | PSoC 5
Lighting & Power Control	cypress.com/go/powerpsoc	
	cypress.com/go/plc	
Memory	cypress.com/go/memory	
Optical & Image Sensing	cypress.com/go/image	
PSoC	cypress.com/go/psoc	
Touch Sensing	cypress.com/go/touch	
USB Controllers	cypress.com/go/USB	
Wireless/RF	cypress.com/go/wireless	

© Cypress Semiconductor Corporation, 2002-2010. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress product. Nor does it convey or imply any license under patent or other rights. Cypress products are not warranted nor intended to be used for medical, life support, life saving, critical control or safety applications, unless pursuant to an express written agreement with Cypress. Furthermore, Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress products in life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Any Source Code (software and/or firmware) is owned by Cypress Semiconductor Corporation (Cypress) and is protected by and subject to worldwide patent protection (United States and foreign), United States copyright laws and international treaty provisions. Cypress hereby grants to licensee a personal, non-exclusive, non-transferable license to copy, use, modify, create derivative works of, and compile the Cypress Source Code and derivative works for the sole purpose of creating custom software and or firmware in support of licensee product to be used only in conjunction with a Cypress integrated circuit as specified in the applicable agreement. Any reproduction, modification, translation, compilation, or representation of this Source Code except as specified above is prohibited without the express written permission of Cypress.

Disclaimer: CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS MATERIAL, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. Cypress reserves the right to make changes without further notice to the materials described herein. Cypress does not assume any liability arising out of the application or use of any product or circuit described herein. Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress' product in a life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Use may be limited by and subject to the applicable Cypress software license agreement.

All products and company names mentioned in this document may be the trademarks of their respective holders.

[+] Feedback